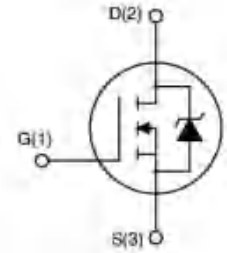


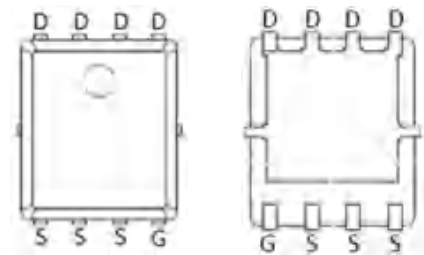
Feature

- 60V,90A
 $R_{DS(on)} < 3.2m\Omega @ V_{GS}=10V$
 $R_{DS(on)} < 4.3m\Omega @ V_{GS}=4.5V$
- Split Gate Trench Technology
- Lead free product is acquired
- Excellent $R_{DS(on)}$ and Low Gate Charge



Application

- PWM applications
- Load Switch
- Power management



PDFN5X6-8L

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity (PCS)
G032N06G	APG032N06G	PDFN5*6-8L	13 inch	-	5000

ABSOLUTE MAXIMUM RATINGS (T_a=25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V _{DS}	60	V
Gate-Source Voltage	V _{GS}	±20	V
Continuous Drain Current (T _a =25°C)	I _D	90	A
Continuous Drain Current (T _a =100°C)	I _D	58	A
Pulsed Drain Current ⁽¹⁾	I _{DM}	390	A
Singel Pulsed Avalanche Energy ⁽²⁾	E _{AS}	500	mJ
Power Dissipation	P _D	120	W
Thermal Resistance from Junction to Case	R _{θJC}	1.04	°C/W
Junction Temperature	T _J	150	°C
Storage Temperature	T _{STG}	-55~ +150	°C

MOSFET ELECTRICAL CHARACTERISTICS(T_a=25°C unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Type	Max	Unit
Static Characteristics						
Drain-source breakdown voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D =250μA	60	-	-	V
Zero gate voltage drain current	I _{DSS}	V _{DS} =60V, V _{GS} = 0V	-	-	1	μA
Gate-body leakage current	I _{GSS}	V _{GS} =±20V, V _{DS} = 0V	-	-	±100	nA
Gate threshold voltage ⁽³⁾	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250μA	2.0	2.8	4.0	V
Drain-source on-resistance ⁽³⁾	R _{DS(on)}	V _{GS} =10V, I _D =20A	-	2.5	3.2	mΩ
		V _{GS} =6V, I _D =15A	-	3.4	4.3	
Dynamic characteristics						
Input Capacitance	C _{iss}	V _{DS} =25V, V _{GS} =0V, f =100KHz	-	4165	-	pF
Output Capacitance	C _{oss}		-	900	-	
Reverse Transfer Capacitance	C _{rss}		-	59	-	
Switching characteristics						
Turn-on delay time	t _{d(on)}	V _{DD} =30V, I _D =25A, R _L =2Ω V _{GS} =10V, R _G =3Ω	-	22.5	-	ns
Turn-on rise time	t _r		-	6.7	-	
Turn-off delay time	t _{d(off)}		-	80.3	-	
Turn-off fall time	t _f		-	26.9	-	
Total Gate Charge	Q _g	V _{DS} =50V, I _D =50A, V _{GS} =10V	-	65	-	nC
Gate-Source Charge	Q _{gs}		-	11.9	-	
Gate-Drain Charge	Q _{gd}		-	9.8	-	
Reverse Recovery Charge	Q _{rr}	I _F =25A, di/dt=100A/us	-	63	-	nC
Reverse Recovery Time	T _{rr}	I _F =25A, di/dt=100A/us	-	58	-	ns
Source-Drain Diode characteristics						
Diode Forward voltage ⁽³⁾	V _{DS}	V _{GS} =0V, I _S =30A	-	-	1.2	V
Diode Forward current ⁽⁴⁾	I _S		-	-	90	A

Notes:

1. Repetitive Rating: pulse width limited by maximum junction temperature
2. EAS Condition: T_J=25°C, V_{DD}=50V, R_G=25 Ω, L=0.5mH
3. Pulse Test: pulse width≤300μs, duty cycle≤2%
4. Surface Mounted on FR4 Board, t≤10 sec

■ Test circuits and waveforms

Figure A: Gate Charge Test Circuit & Waveforms

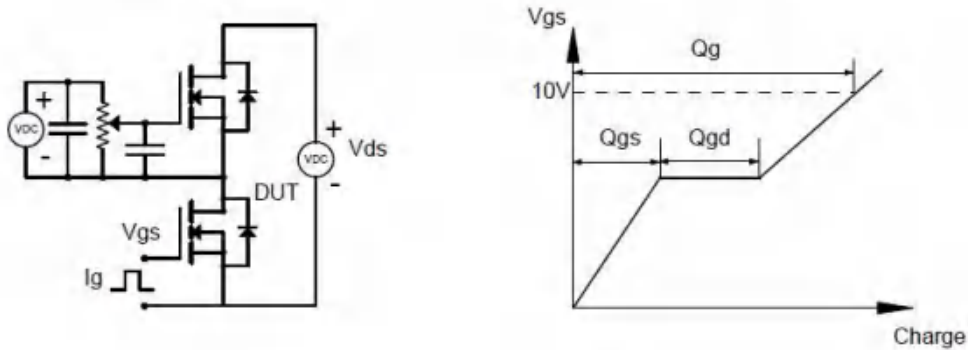


Figure B: Resistive Switching Test Circuit & Waveforms

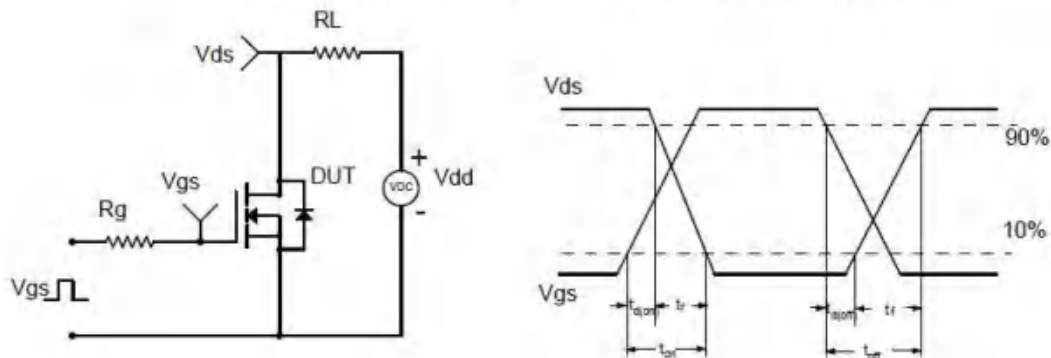


Figure C: Unclamped Inductive Switching (UIS) Test

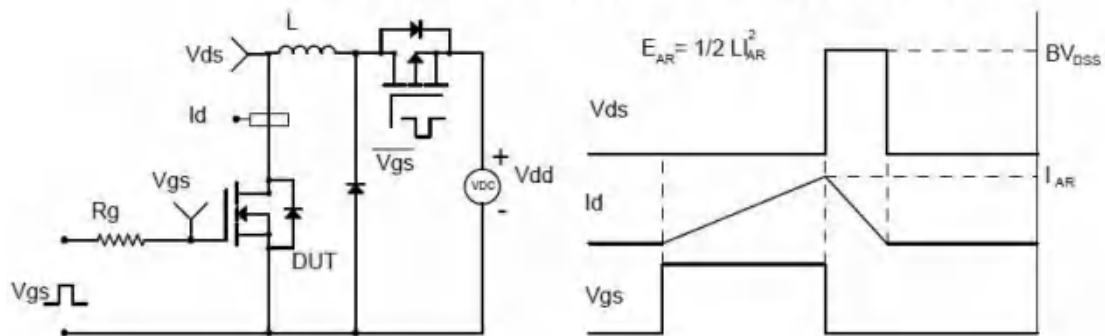
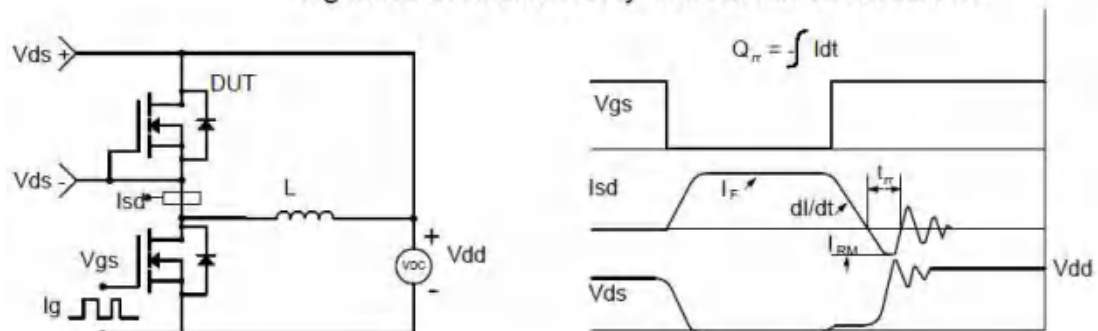


Figure D: Diode Recovery Test Circuit & Waveforms



■ Typical Performance Characteristics

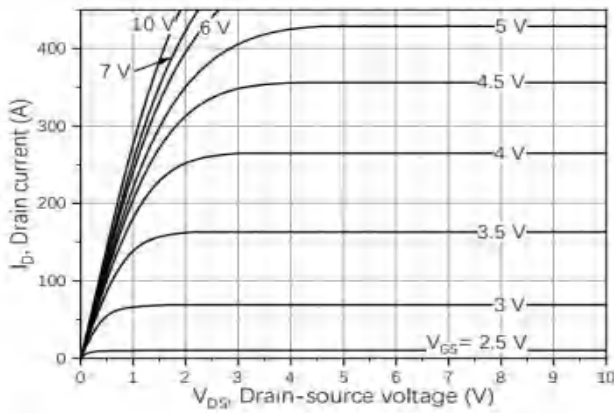


Figure1. Output Characteristics

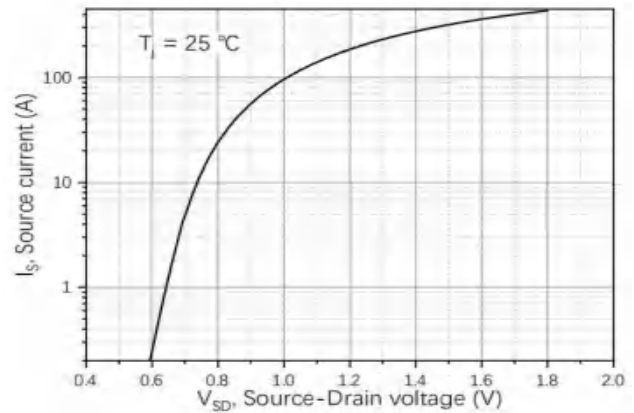


Figure2. Transfer Characteristics

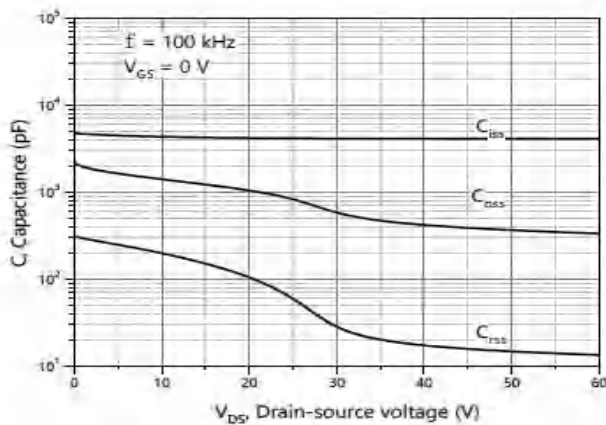


Figure3. Capacitance Characteristics

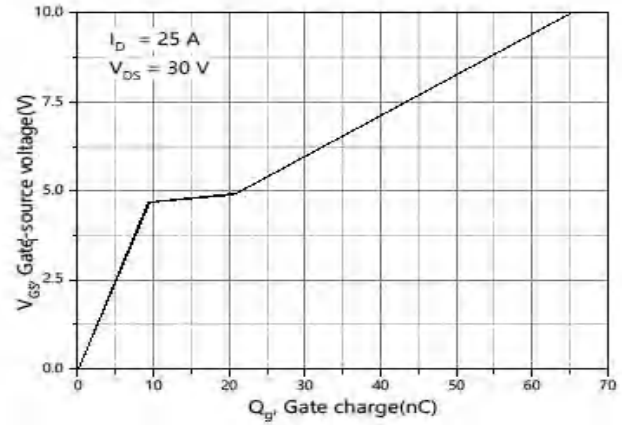


Figure4. Gate Charge

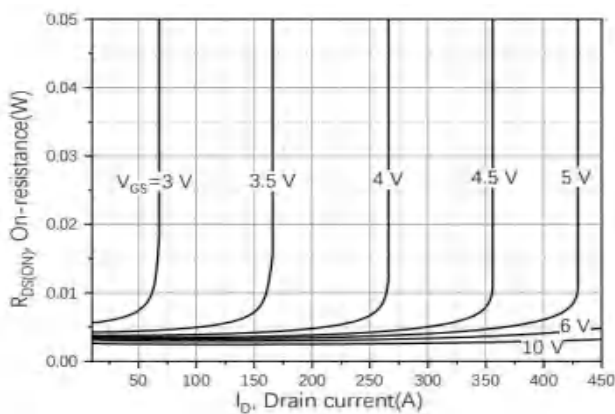


Figure5. Drain-Source on Resistance

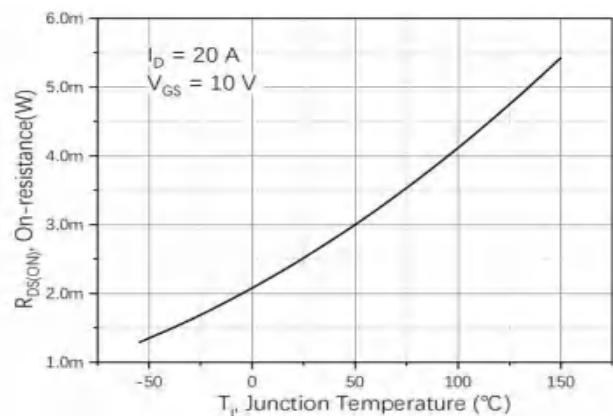


Figure6. Drain-Source on Resistance

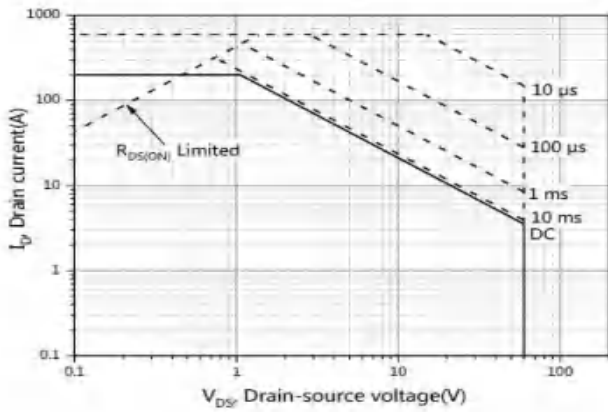


Figure7. Safe Operation Area

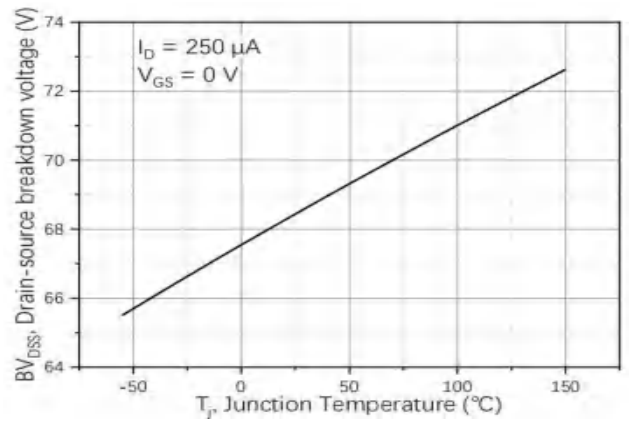
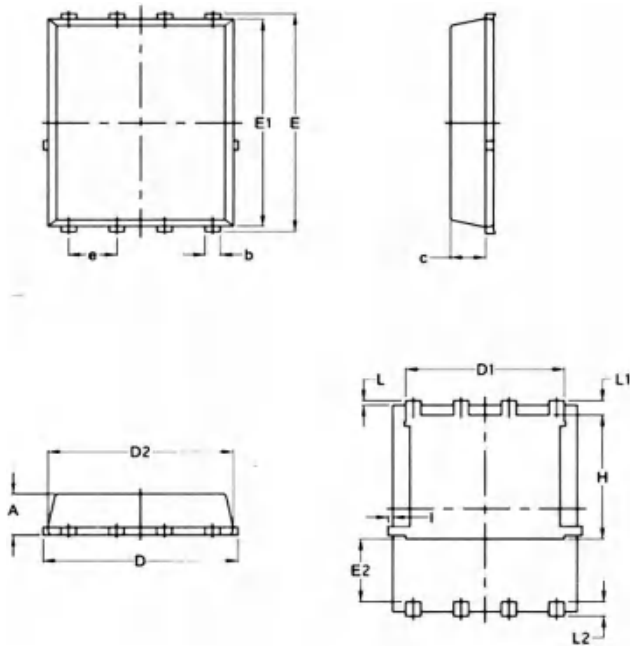


Figure8. Drain-source breakdown voltage

PDFN5*6-8L Package Information



PDFN5X6-8L

SYMBOL	COMMON			
	MM		INCH	
	MIN.	MAX.	MIN.	MAX.
A	1.03	1.17	0.0406	0.0461
b	0.34	0.48	0.0134	0.0189
c	0.824	0.970	0.0324	0.0382
D	4.80	5.40	0.1890	0.2126
D1	4.11	4.31	0.1618	0.1697
D2	4.80	5.00	0.1890	0.1969
E	5.95	6.15	0.2343	0.2421
E1	5.65	5.85	0.2224	0.2303
E2	1.60	—	0.0630	—
e	1.27 BSC		0.05 BSC	
L	0.05	0.25	0.0020	0.0098
L1	0.38	0.50	0.0150	0.0197
L2	0.38	0.50	0.0150	0.0197
H	3.30	3.50	0.1299	0.1378
I	—	0.18	—	0.0070